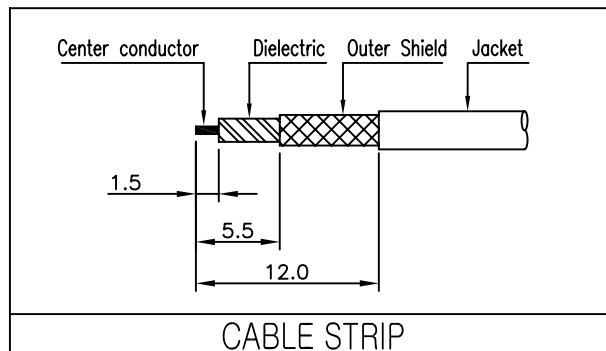
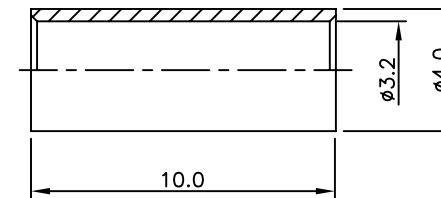
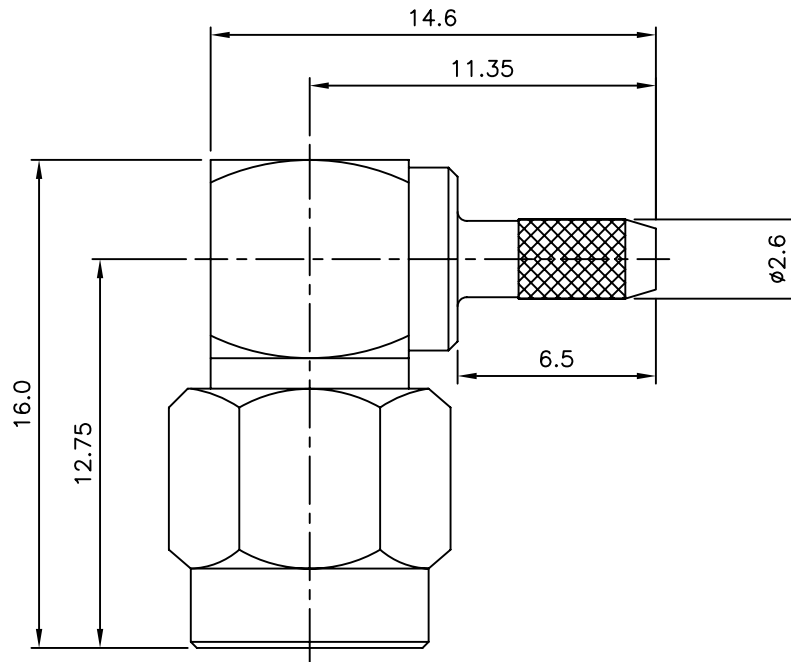


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	M.H.SONG	I.C.KIM	2014.04.23.
1	[설번처리(No.201606-0001)] Cover 들뜸 및 비정상적으로 안착되는 현상으로 인한 Cover CODE 변경	C.K.KIM	I.C.KIM	2016.06.09.
2	커넥터 압착부 바디 부러짐 현상 방지로 인한 R추가	S.Y.EUN	S.H.KIM	2021.12.16.



8	SPRING RING	1	SUS	부동태 처리	DSR00002-5/1 (R2001)
7	COVER	1	MBsBD	Gold Plate	DCO00026-5/2 DCO00031-5/1 (L2013)
6	COUPLING CAP	1	MBsBD	Nickel Plate	DCU00005-5/2 (K2011)
5	INSULATOR	1	TEFLON	White	DIN02381-N/1
4	GASKET	1	SILICONE RUB		DGK00004-N/1 (G2001)
3	FERRULE	1	MBsBD	Nickel Plate	DFE00034-5/1
2	CONTACT	1	MBsBD	Gold Plate	DCT03118-5/1
1	1-2 원형 BODY	1	MBsBD	Gold Plate	DBD01283-3/1 (D2109B)
	1-1 사각 BODY	1	MBsBD	Gold Plate	DBD00216-3/1 (D2109A)
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2021. 12. 16.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	S.H.KIM	
MATERIAL	-	CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMA75 CABLE PL RG179(75Ω)
		DRAWN BY	S.Y.EUN	
FINISH	-	SCALE	4/1	A4 DWG NO. CN03214-7/1 REVISION 2 SHEET 1 of 1
		UNIT	mm	